

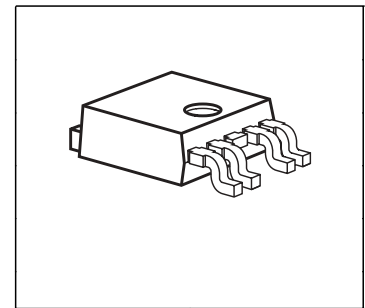
Smart High-Side Power Switch

Features

- Overload protection
- Current limitation
- Short circuit protection
- Thermal shutdown with restart
- Overvoltage protection (including load dump)
- Fast demagnetization of inductive loads
- Reverse battery protection with external resistor
- Open drain diagnostic output for overtemperature and short circuit
- Open load detection in OFF - State with external resistor
- CMOS compatible input
- Loss of GND and loss of V_{bb} protection
- ESD - Protection
- Very low standby current
- Green product (RoHS-compliant)

Product Summary

Overvoltage protection	$V_{bb(AZ)}$	62	V
Operating voltage	$V_{bb(on)}$	6...52	V
On-state resistance	R_{ON}	200	m Ω
Nominal load current	$I_{L(ISO)}$	1.8	A



PG-T0252-5-11

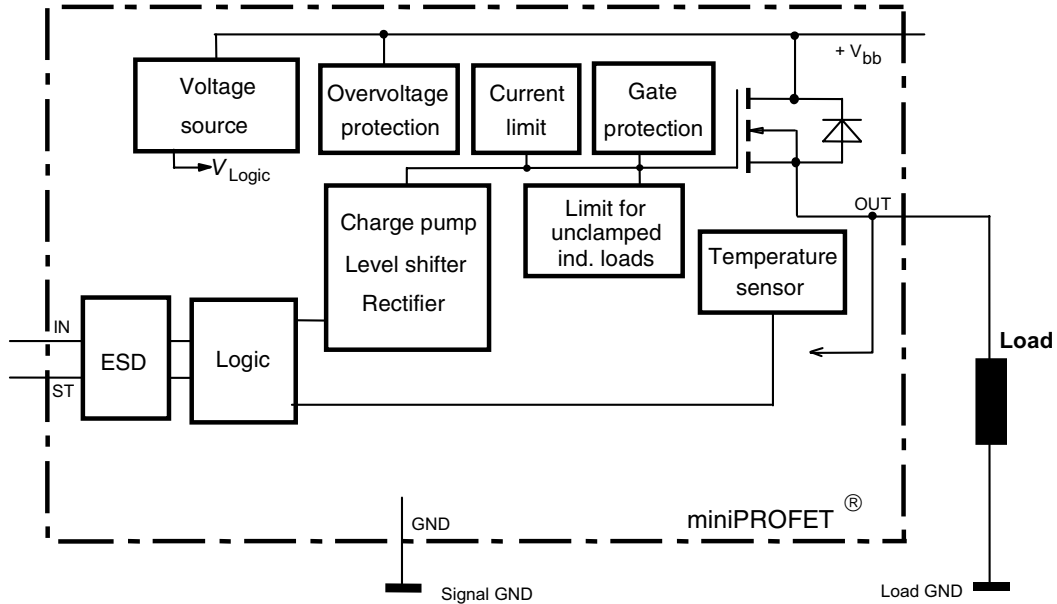
Application

- All types of resistive, inductive and capacitive loads
- μ C compatible power switch for 12 V, 24 V and 42 V DC applications
- Replaces electromechanical relays and discrete circuits

General Description

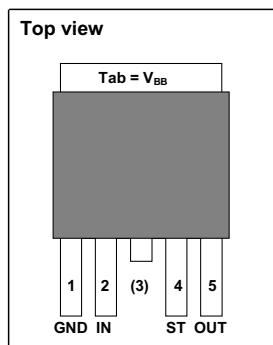
N channel vertical power FET with charge pump, ground referenced CMOS compatible input and diagnostic feedback, monolithically integrated in Smart SIPMOS[®] technology. Providing embedded protective functions.

Block Diagram



Pin	Symbol	Function
1	GND	Logic ground
2	IN	Input, activates the power switch in case of logic high signal
3	Vbb	Positive power supply voltage
4	ST	Diagnostic feedback
5	OUT	Output to the load
TAB	Vbb	Positive power supply voltage

Pin configuration



Maximum Ratings at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Supply voltage	V_{bb}	52	V
Supply voltage for full short circuit protection	$V_{bb(SC)}$	50	
Continuous input voltage	V_{IN}	-10 ... +16	
Load current (Short - circuit current, see page 5)	I_L	self limited	A
Current through input pin (DC)	I_{IN}	± 5	mA
Operating temperature	T_j	-40 ... +150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 ... +150	
Power dissipation ¹⁾	P_{tot}	41.6	W
Inductive load switch-off energy dissipation ¹⁾²⁾ single pulse, (see page 9) $T_j = 150^\circ\text{C}$, $I_L = 1\text{ A}$	E_{AS}	150	mJ
Load dump protection ²⁾ $V_{LoadDump}^{3)} = V_A + V_S$ $R_l = 2\Omega$, $t_d = 400\text{ms}$, $V_{IN} = \text{low or high}$, $V_A = 13.5\text{V}$ $R_L = 13.5\ \Omega$ $R_L = 27\ \Omega$	$V_{Loaddump}$	73.5 88.5	V
Electrostatic discharge voltage (Human Body Model) according to ANSI EOS/ESD - S5.1 - 1993 ESD STM5.1 - 1998 Input pin all other pins	V_{ESD}	± 1 ± 5	kV

Thermal Characteristics

junction - case:	R_{thJC}	-	-	3	K/W
Thermal resistance @ min. footprint	$R_{th(JA)}$	-	80	-	K/W
Thermal resistance @ 6 cm ² cooling area ¹⁾	$R_{th(JA)}$	-	45	60	

¹⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6 cm² (one layer, 70µm thick) copper area for drain connection. PCB is vertical without blown air.

²⁾ not subject to production test, specified by design

³⁾ $V_{Loaddump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839.

Supply voltages higher than $V_{bb(AZ)}$ require an external current limit for the GND pin, e.g. with a 150Ω resistor in GND connection. A resistor for the protection of the input is integrated.

Electrical Characteristics

Parameter and Conditions at $T_j = -40...+150^\circ\text{C}$, $V_{bb} = 12..42\text{V}$, unless otherwise specified	Symbol	Values			Unit
		min.	typ.	max.	

Load Switching Capabilities and Characteristics

On-state resistance $T_j = 25^\circ\text{C}$, $I_L = 1\text{ A}$, $V_{bb} = 9...52\text{ V}$ $T_j = 150^\circ\text{C}$	R_{ON}	-	150	200	m Ω
		-	270	380	
Nominal load current; Device on PCB ¹⁾ $T_C = 85^\circ\text{C}$, $V_{ON} = 0.5\text{ V}$	$I_{L(ISO)}$	1.8	2.2	-	A
Turn-on time to 90% V_{OUT} $R_L = 47\ \Omega$	t_{on}	-	80	180	μs
Turn-off time to 10% V_{OUT} $R_L = 47\ \Omega$	t_{off}	-	80	200	
Slew rate on 10 to 30% V_{OUT} , $R_L = 47\ \Omega$, $V_{bb} = 13.5\text{ V}$	dV/dt_{on}	-	0.7	2	V/ μs
Slew rate off 70 to 40% V_{OUT} , $R_L = 47\ \Omega$, $V_{bb} = 13.5\text{ V}$	$-dV/dt_{off}$	-	0.9	2	

Operating Parameters

Operating voltage	$V_{bb(on)}$	6	-	52	V
Undervoltage shutdown of charge pump $T_j = -40...+85^\circ\text{C}$ $T_j = 150^\circ\text{C}$	$V_{bb(under)}$	-	-	4	
		-	-	5.5	
Undervoltage restart of charge pump	$V_{bb(u\ cp)}$	-	4	5.5	
Standby current $T_j = -40...+85^\circ\text{C}$, $V_{IN} = \text{low}$ $T_j = +150^\circ\text{C}$ ²⁾ , $V_{IN} = \text{low}$	$I_{bb(off)}$	-	-	15	μA
		-	-	18	
Leakage output current (included in $I_{bb(off)}$) $V_{IN} = \text{low}$	$I_{L(off)}$	-	-	5	
Operating current $V_{IN} = \text{high}$	I_{GND}	-	0.8	2	mA

¹Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical without blown air.

²higher current due temperature sensor

Electrical Characteristics

Parameter and Conditions	Symbol	Values			Unit
		min.	typ.	max.	
at $T_j = -40...+150^\circ\text{C}$, $V_{bb} = 12..42\text{V}$, unless otherwise specified					
Protection Functions¹⁾					
Initial peak short circuit current limit (pin 3 to 5) $T_j = -40^\circ\text{C}$, $V_{bb} = 20\text{V}$, $t_m = 150\ \mu\text{s}$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$ $T_j = -40...+150^\circ\text{C}$, $V_{bb} > 40\text{V}$, (see page 12)	$I_{L(SCp)}$	- - 4 -	- 6.5 - 5 ²⁾	9 - - -	A
Repetitive short circuit current limit $T_j = T_{jt}$ (see timing diagrams) $V_{bb} < 40\text{V}$ $V_{bb} > 40\text{V}$	$I_{L(SCr)}$	- -	6 4.5	- -	
Output clamp (inductive load switch off) at $V_{OUT} = V_{bb} - V_{ON(CL)}$, $I_{bb} = 4\text{mA}$	$V_{ON(CL)}$	59	63	-	V
Overvoltage protection ³⁾ $I_{bb} = 4\text{mA}$	$V_{bb(AZ)}$	62	-	-	
Thermal overload trip temperature	T_{jt}	150	-	-	$^\circ\text{C}$
Thermal hysteresis	ΔT_{jt}	-	10	-	K
Reverse Battery					
Reverse battery ⁴⁾	$-V_{bb}$	-	-	52	V
Drain-source diode voltage ($V_{OUT} > V_{bb}$) $T_j = 150^\circ\text{C}$	$-V_{ON}$	-	600	-	mV

¹Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

²not subject to production test, specified by design

³ see also $V_{ON(CL)}$ in circuit diagram on page 8

⁴Requires a $150\ \Omega$ resistor in GND connection. The reverse load current through the intrinsic drain-source diode has to be limited by the connected load. Power dissipation is higher compared to normal operating conditions due to the voltage drop across the drain-source diode. The temperature protection is not active during reverse current operation! Input current has to be limited (see max. ratings page 3).

Electrical Characteristics

Parameter and Conditions at $T_j = -40...+150^\circ\text{C}$, $V_{bb} = 12..42\text{V}$, unless otherwise specified	Symbol	Values			Unit
		min.	typ.	max.	
Input and Status feedback					
Input turn-on threshold voltage	$V_{IN(T+)}$	-	-	2.2	V
Input turn-off threshold voltage	$V_{IN(T-)}$	0.8	-	-	
Input threshold hysteresis	$\Delta V_{IN(T)}$	-	0.4	-	
Off state input current $V_{IN} = 0.7\text{ V}$	$I_{IN(off)}$	1	-	25	μA
On state input current $V_{IN} = 5\text{ V}$	$I_{IN(on)}$	3	-	25	
Status output (open drain), Zener limit voltage $I_{ST} = 1.6\text{ mA}$	$V_{ST(high)}$	5.4	6.1	-	V
Status output (open drain), ST low voltage $T_j = -40...+25^\circ\text{C}$, $I_{ST} = 1.6\text{ mA}$ $T_j = 150^\circ\text{C}$, $I_{ST} = 1.6\text{ mA}$	$V_{ST(low)}$	-	-	0.4 0.6	
Status invalid after positive input slope ¹⁾ $V_{bb} = 20\text{ V}$	$t_{d(ST+)}$	-	120	160	μs
Status invalid after negative input slope ¹⁾	$t_{d(ST-)}$	-	250	400	
Input resistance (see page 8)	R_I	2	3.5	5	$\text{k}\Omega$

Diagnostic Characteristics

Short circuit detection voltage	$V_{OUT(SC)}$	-	2.8	-	V
Open load detection voltage ²⁾	$V_{OUT(OL)}$	-	3	4	
Internal output pull down ³⁾ (see page 9 and 14) $V_{OUT(OL)} = 4\text{ V}$	R_O	65	200	750	$\text{k}\Omega$

¹no delay time after overtemperature switch off and short circuit in on-state

²External pull up resistor required for open load detection in off state.

³not subject to production test, specified by design

	Input level	Output level	Status
Normal operation	L	L	H
	H	H	H
Short circuit to GND	L	L	H
	H	L *	L
Short circuit to V_{bb} (in off-state)	L	H	L
	H	H	H
Overload	L	L	H
	H	H **	H
Overtemperature	L	L	H
	H	L	L
Open Load in off-state	L	Z	H (L^1)
	H	H	H

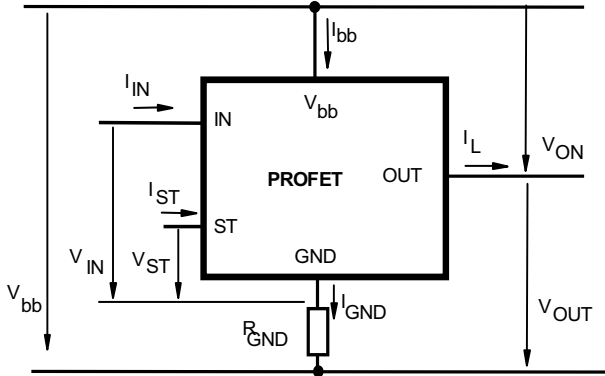
*) Out ="L": $V_{OUT} < 2.8V$ typ.

***) Out ="H": $V_{OUT} > 2.8V$ typ.

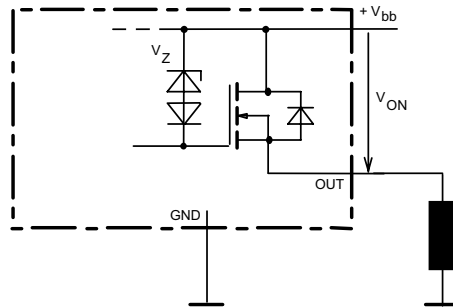
Z = high impedance, potential depends on external circuit

¹with external resistor between V_{bb} and OUT

Terms

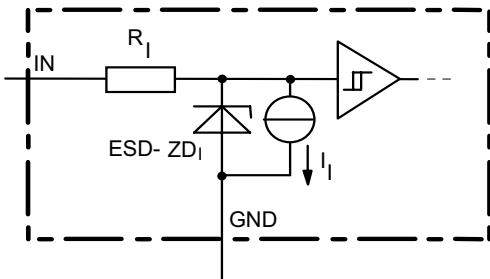


Inductive and overvoltage output clamp



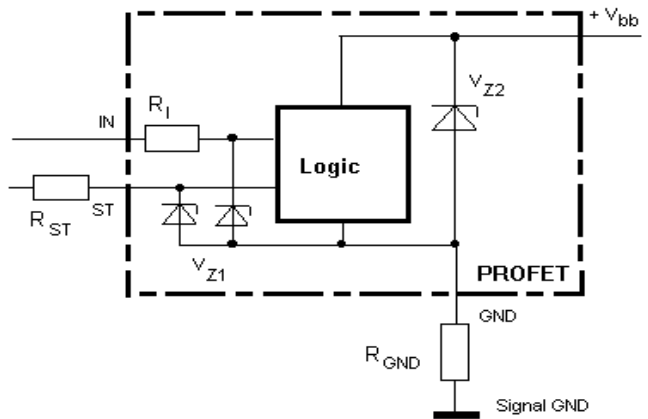
V_{ON} clamped to 59V min.

Input circuit (ESD protection)



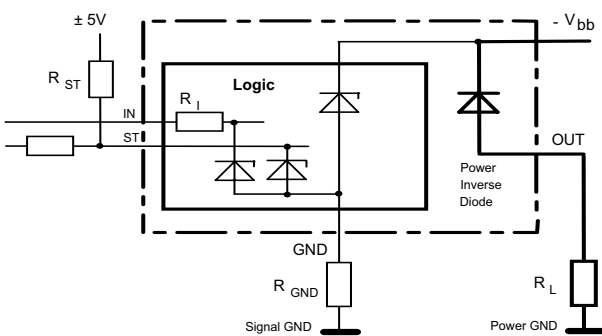
The use of ESD zener diodes as voltage clamp at DC conditions is not recommended

Overvoltage protection of logic part



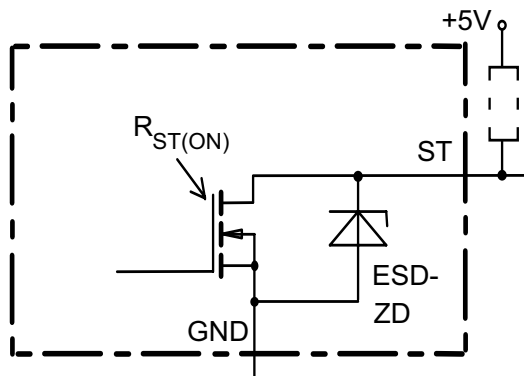
$V_{Z1}=6.1V$ typ., $V_{Z2}=V_{bb(AZ)}=62V$ min.,
 $R_I=3.5\text{ k}\Omega$ typ., $R_{GND}=150\Omega$

Reverse battery protection



$R_{GND}=150\Omega$, $R_I=3.5\text{ k}\Omega$ typ.,
Temperature protection is not active during inverse current

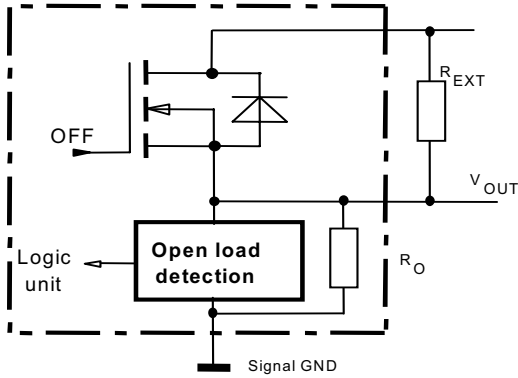
Status output



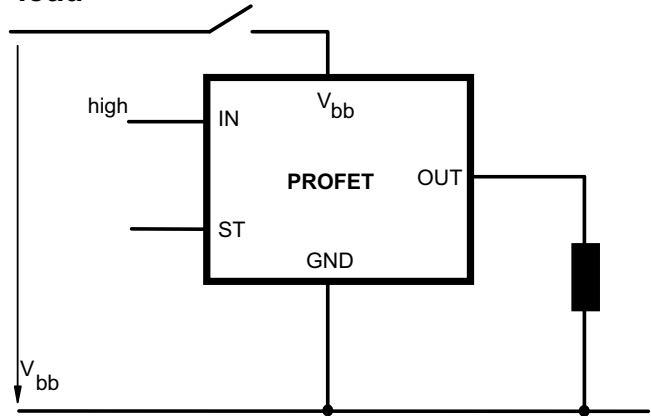
Open-load detection

OFF-state diagnostic condition:

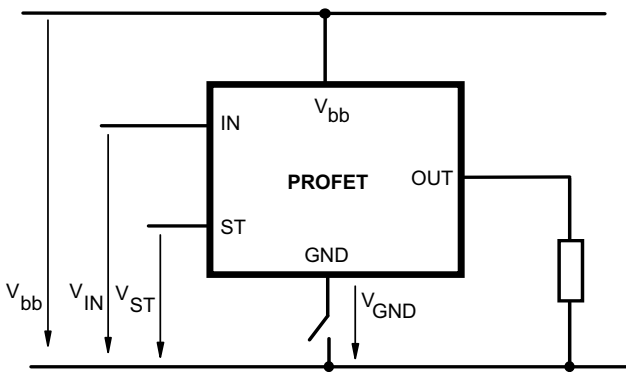
$V_{OUT} > 3V$ typ.; $I_N = low$



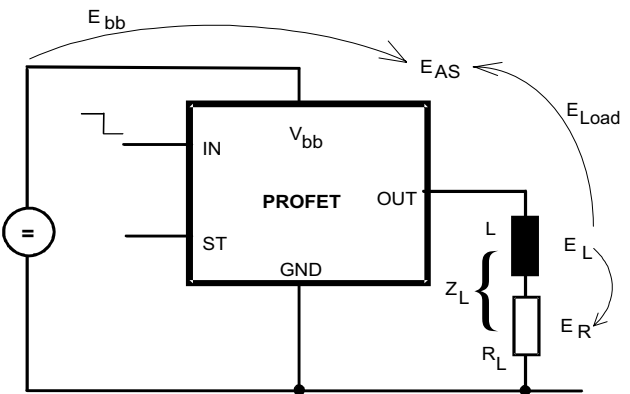
V_{bb} disconnect with charged inductive load



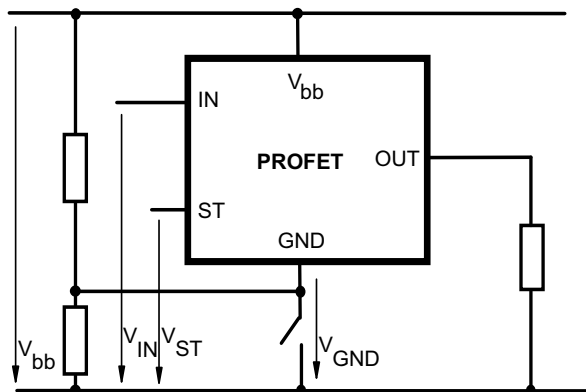
GND disconnect



Inductive Load switch-off energy dissipation



GND disconnect with GND pull up



Energy stored in load inductance: $E_L = \frac{1}{2} * L * I_L^2$

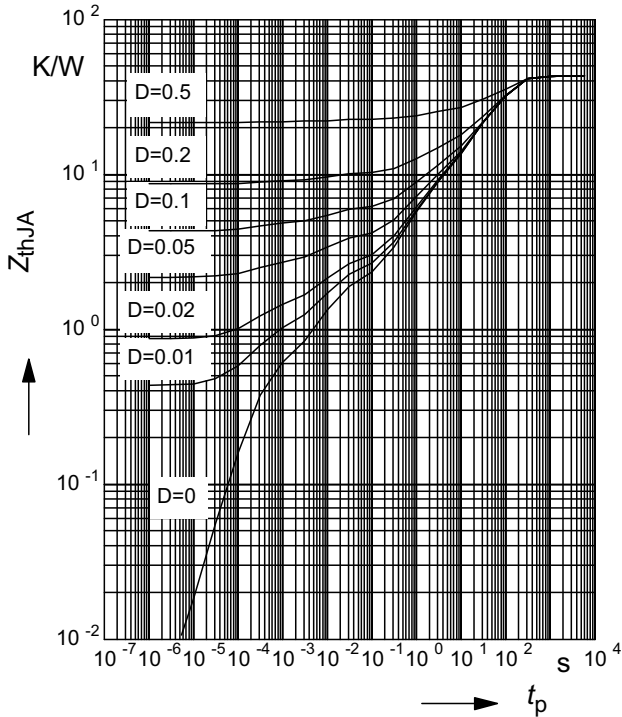
While demagnetizing load inductance, the energy dissipated in PROFET is $E_{AS} = E_{bb} + E_L - E_R = V_{ON(CL)} * i_L(t) dt$, with an approximate solution for $R_L > 0\Omega$:

$$E_{AS} = \frac{I_L * L}{2 * R_L} * (V_{bb} + |V_{OUT(CL)}|) * \ln\left(1 + \frac{I_L * R_L}{|V_{OUT(CL)}|}\right)$$

Typ. transient thermal impedance

$Z_{thJA} = f(t_p)$ @ 6cm² heatsink area

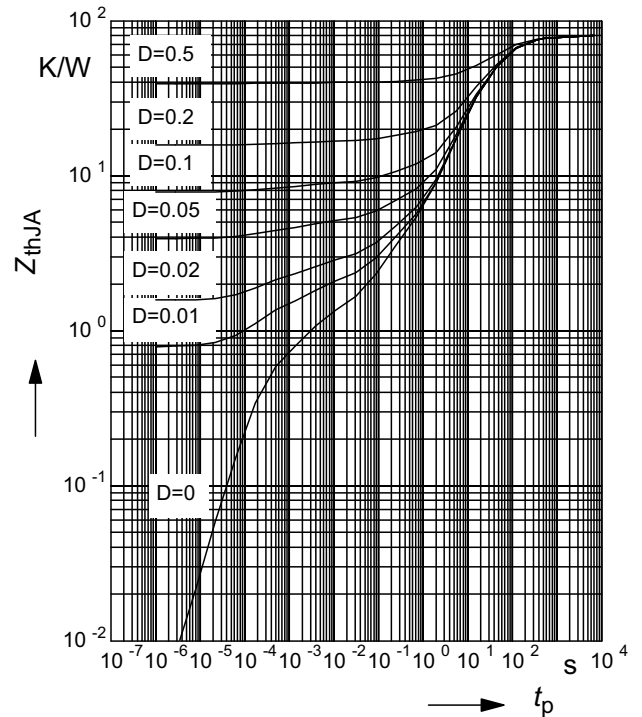
Parameter: $D = t_p / T$



Typ. transient thermal impedance

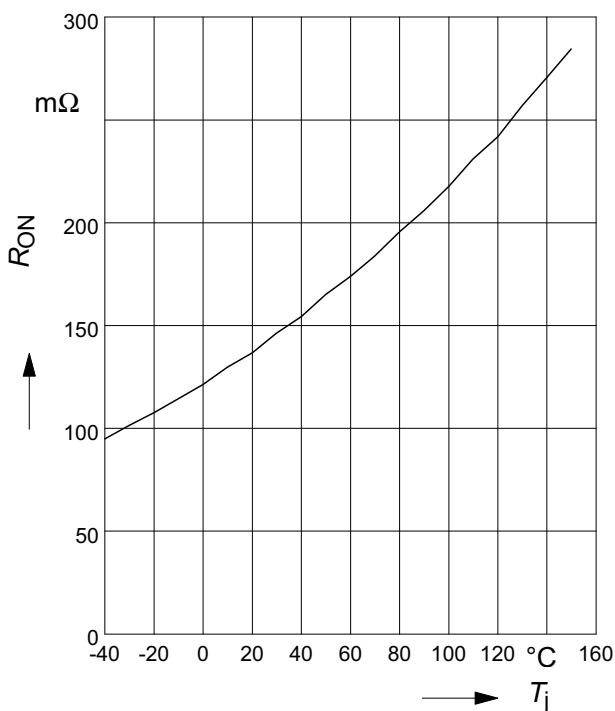
$Z_{thJA} = f(t_p)$ @ min. footprint

Parameter: $D = t_p / T$



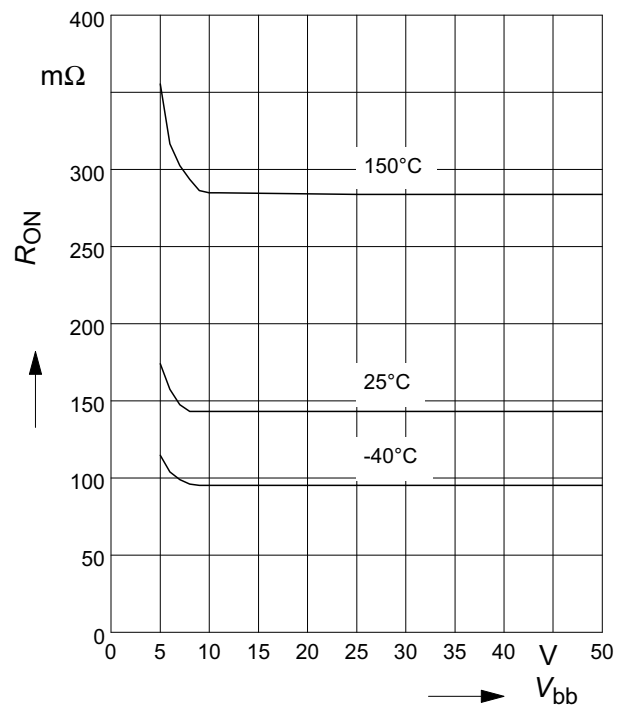
Typ. on-state resistance

$R_{ON} = f(T_j)$; $V_{bb} = 13.5V$; $V_{in} = \text{high}$



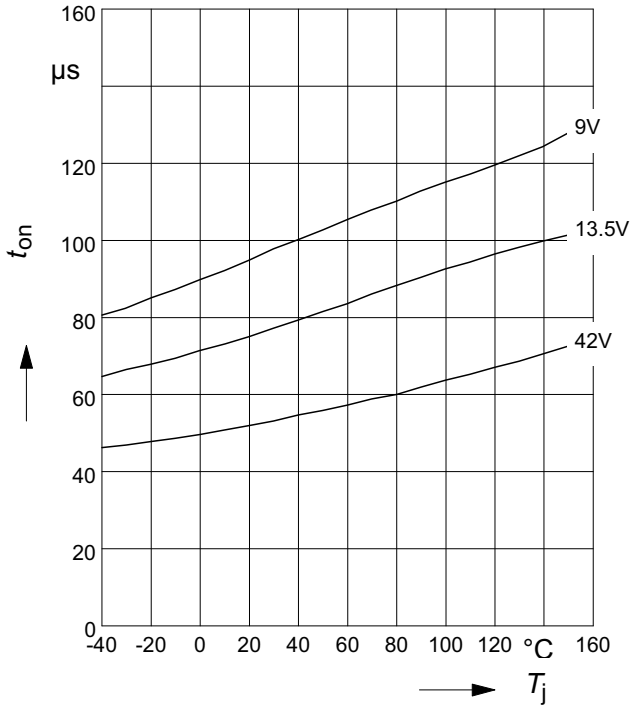
Typ. on-state resistance

$R_{ON} = f(V_{bb})$; $I_L = 1A$; $V_{in} = \text{high}$



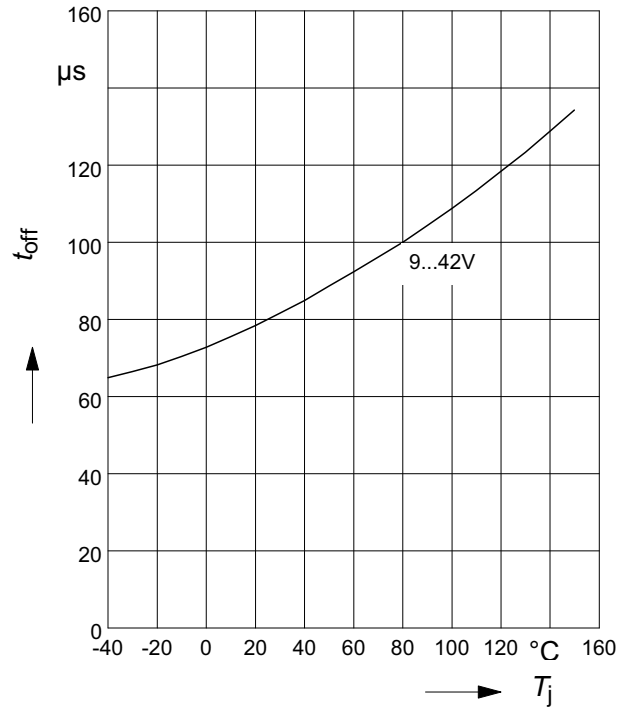
Typ. turn on time

$t_{on} = f(T_j); R_L = 47\Omega$



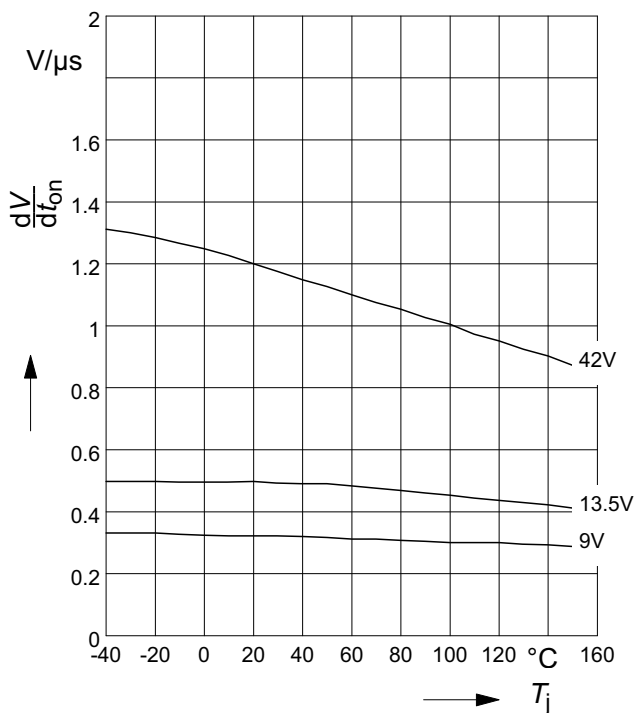
Typ. turn off time

$t_{off} = f(T_j); R_L = 47\Omega$



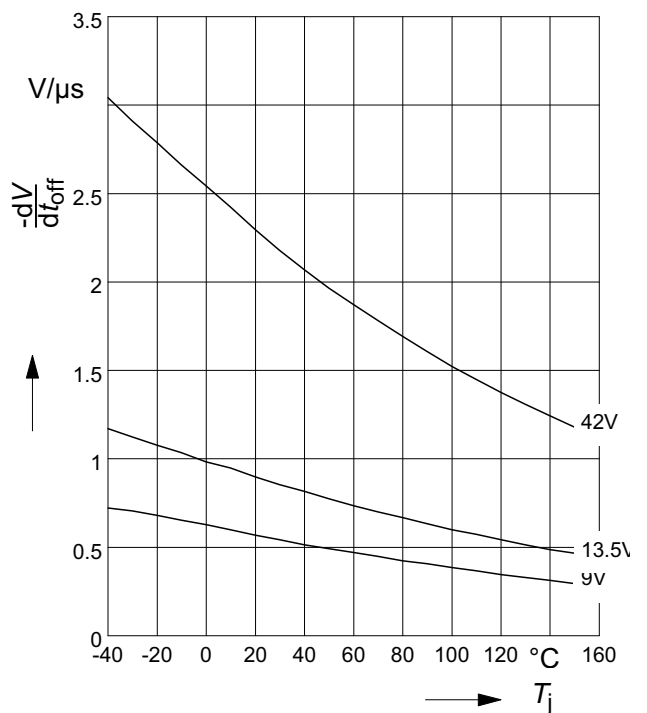
Typ. slew rate on

$dV/dt_{on} = f(T_j); R_L = 47\Omega$



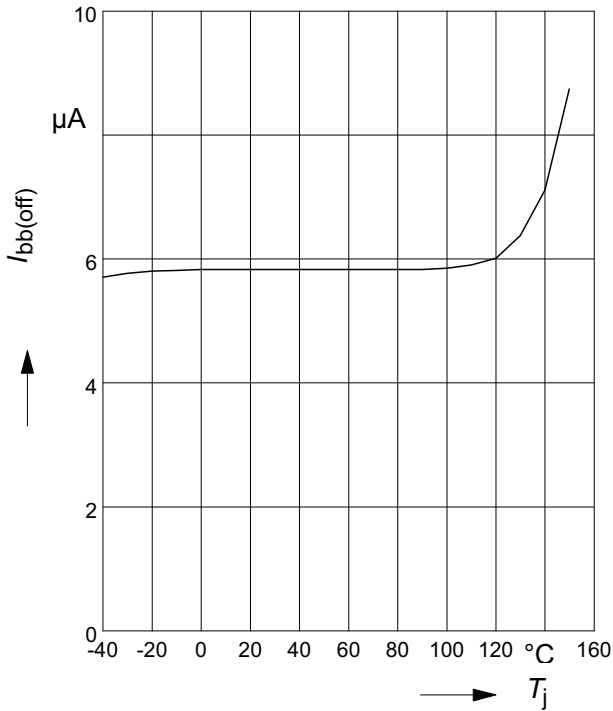
Typ. slew rate off

$dV/dt_{off} = f(T_j); R_L = 47\Omega$



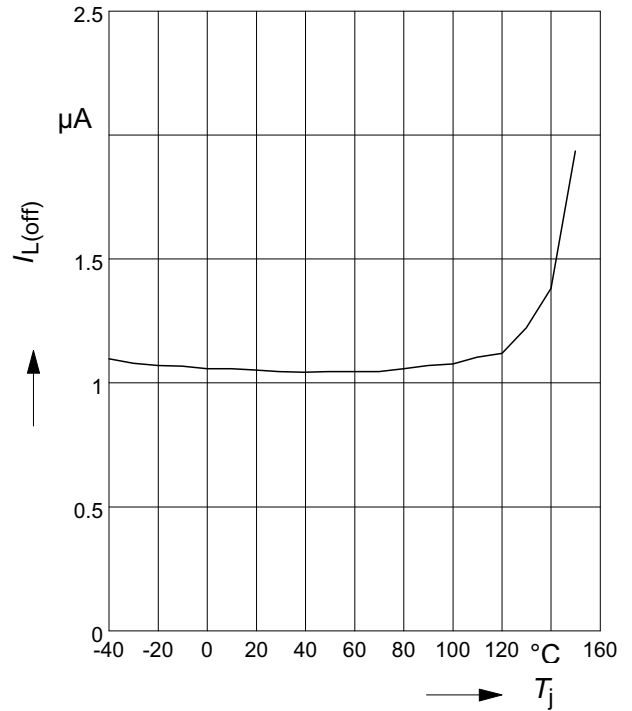
Typ. standby current

$I_{bb(off)} = f(T_j)$; $V_{bb} = 42V$; $V_{IN} = low$



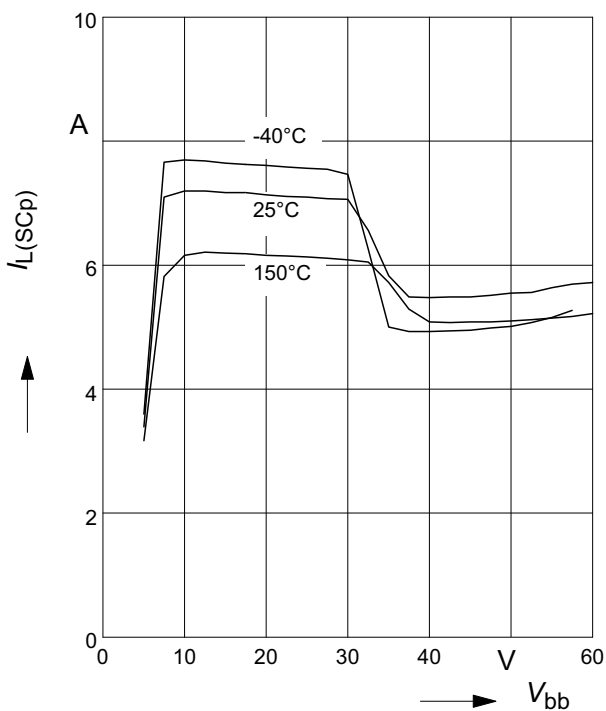
Typ. leakage current

$I_{L(off)} = f(T_j)$; $V_{bb} = 42V$; $V_{IN} = low$



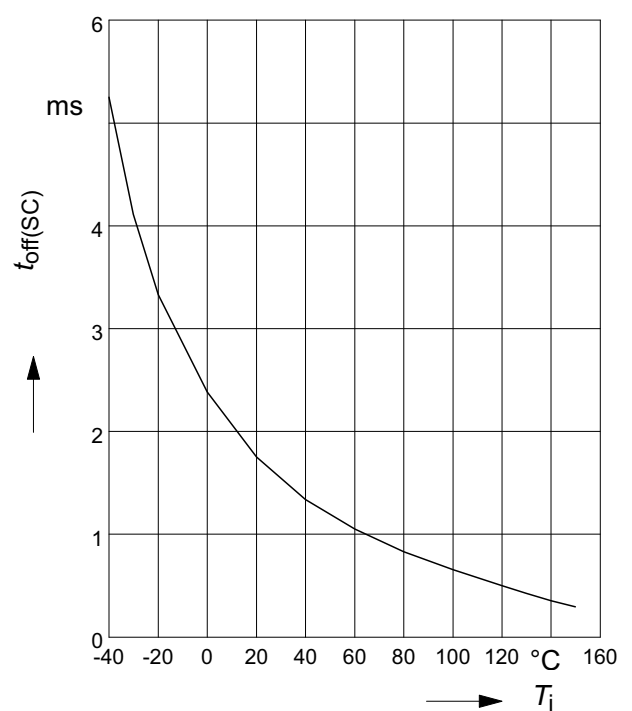
Typ. initial peak short circuit current limit

$I_{L(SCp)} = f(V_{bb})$



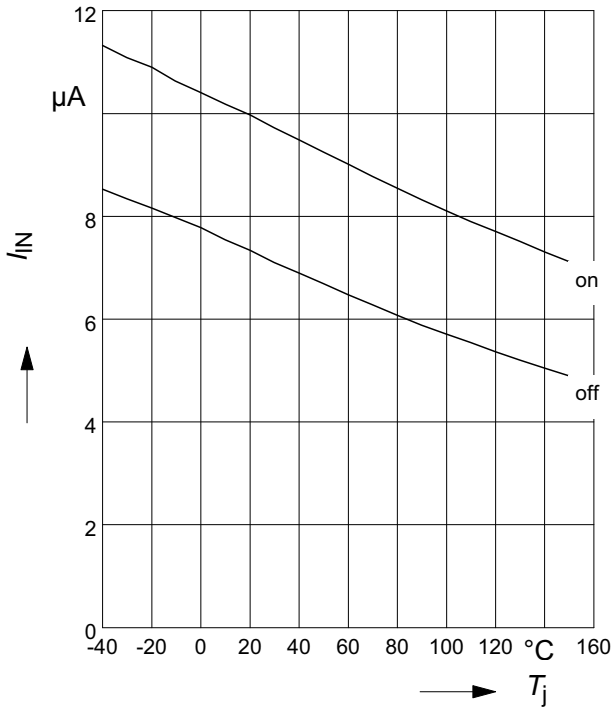
Typ. initial short circuit shutdown time

$t_{off(SC)} = f(T_{j,start})$; $V_{bb} = 20V$



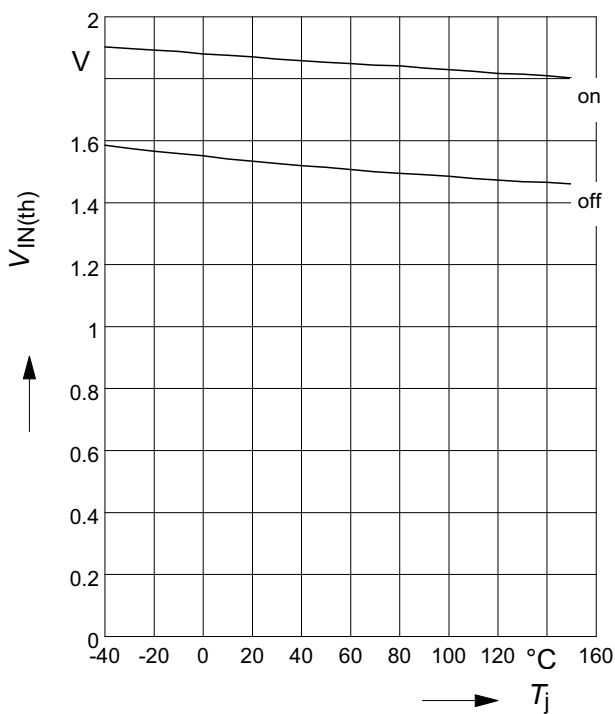
Typ. input current

$I_{IN(on/off)} = f(T_j)$; $V_{bb} = 13.5V$; $V_{IN} = \text{low/high}$
 $V_{INlow} \leq 0.7V$; $V_{INhigh} = 5V$



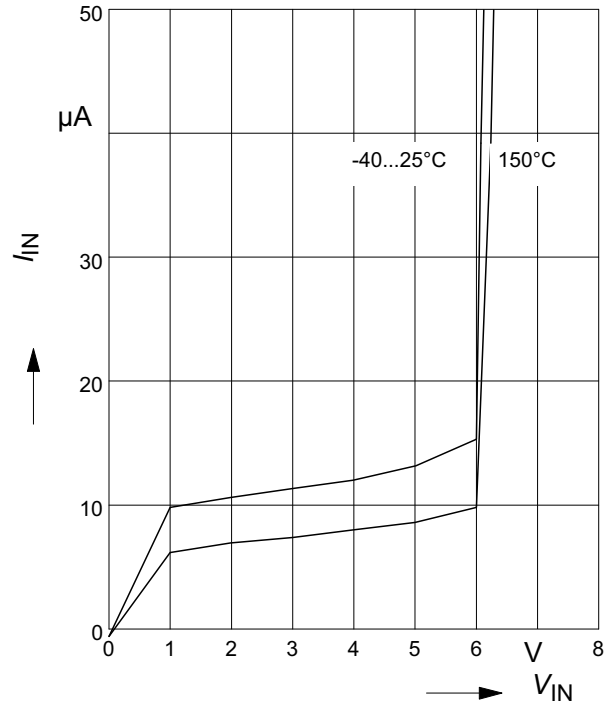
Typ. input threshold voltage

$V_{IN(th)} = f(T_j)$; $V_{bb} = 13.5V$



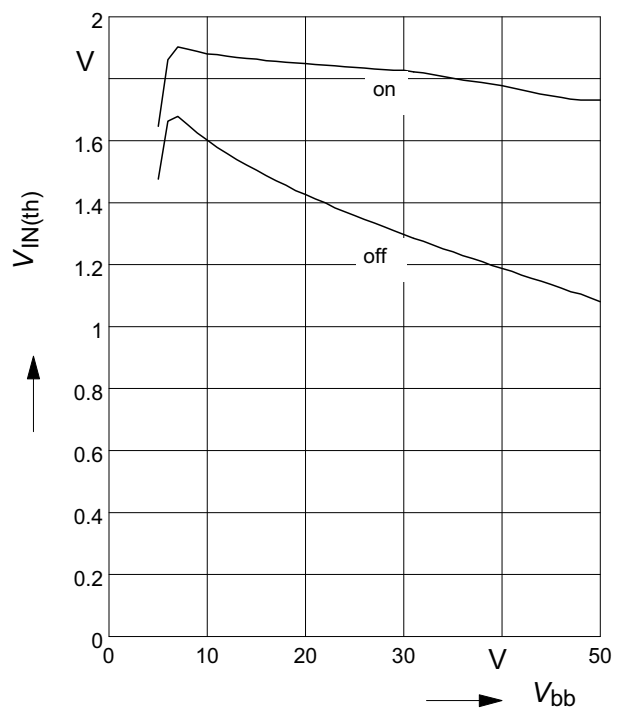
Typ. input current

$I_{IN} = f(V_{IN})$; $V_{bb} = 13.5V$



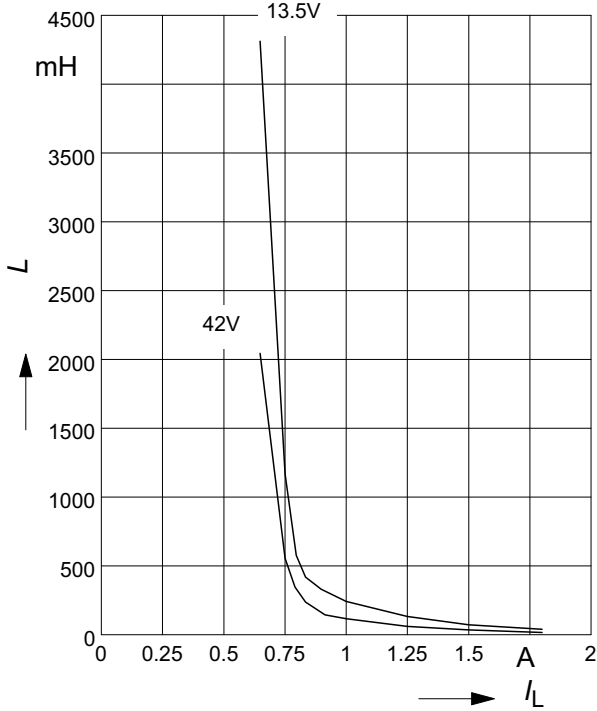
Typ. input threshold voltage

$V_{IN(th)} = f(V_{bb})$; $T_j = 25^{\circ}C$



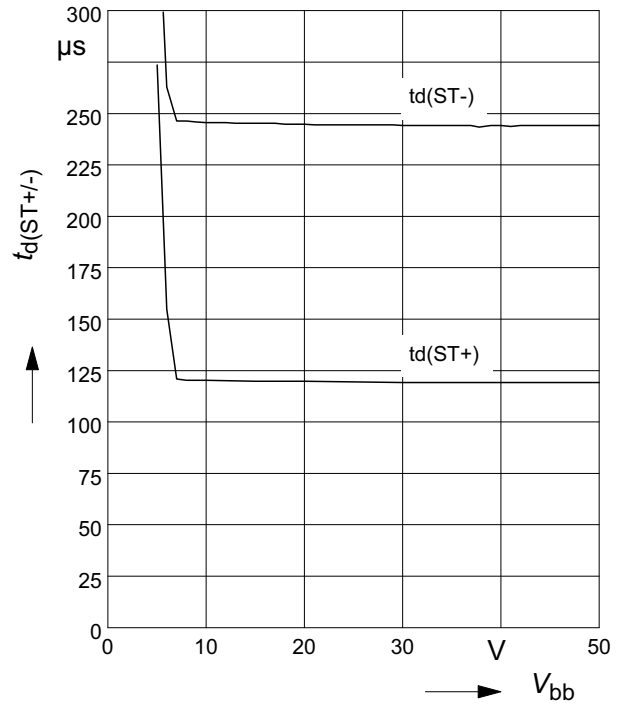
**Maximum allowable load inductance
for a single switch off**

$L = f(I_L); T_{jstart}=150^{\circ}\text{C}, R_L=0\Omega$



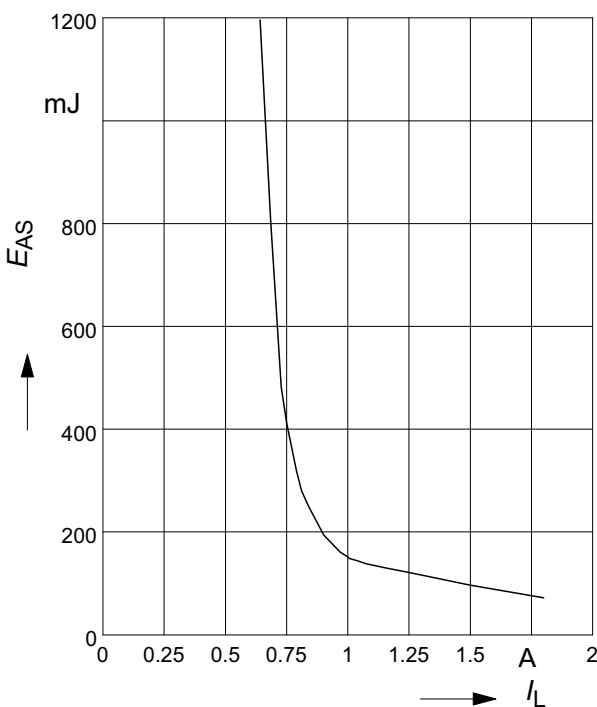
Typ. status delay time

$t_{d(ST+/-)} = f(V_{bb}); T_j = 25^{\circ}\text{C}$



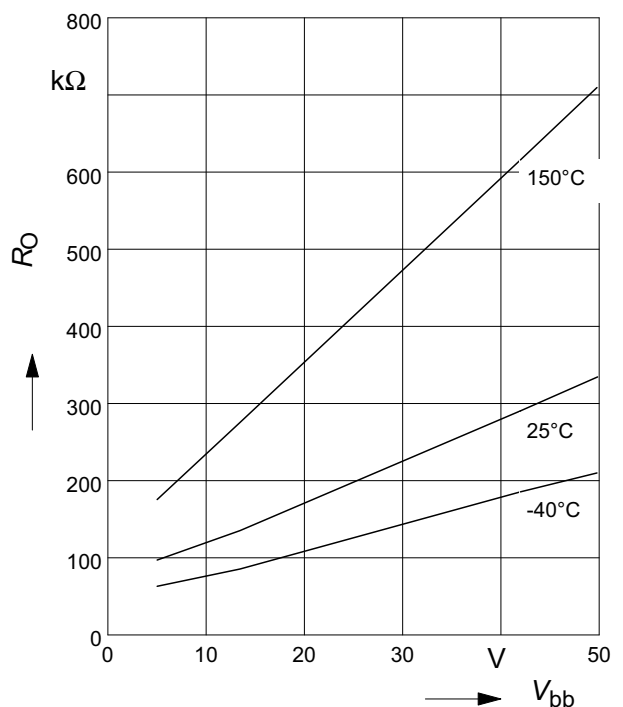
**Maximum allowable inductive switch-off
energy, single pulse**

$E_{AS} = f(I_L); T_{jstart} = 150^{\circ}\text{C}, V_{bb} = 13.5\text{V}$



Typ. internal output pull down

$R_O = f(V_{bb})$



Timing diagrams

Figure 1a: V_{bb} turn on:

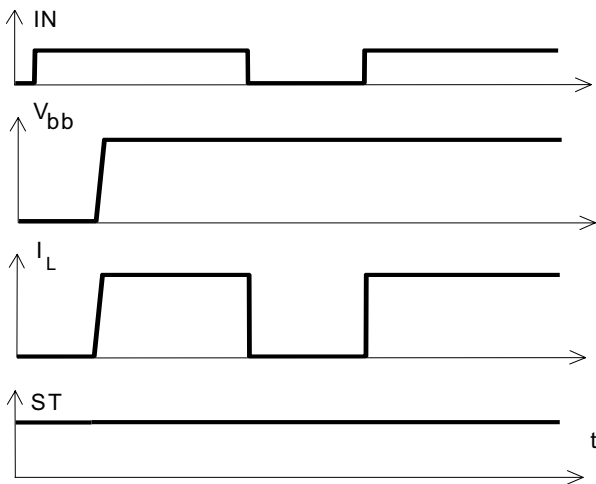


Figure 2b: Switching a lamp,

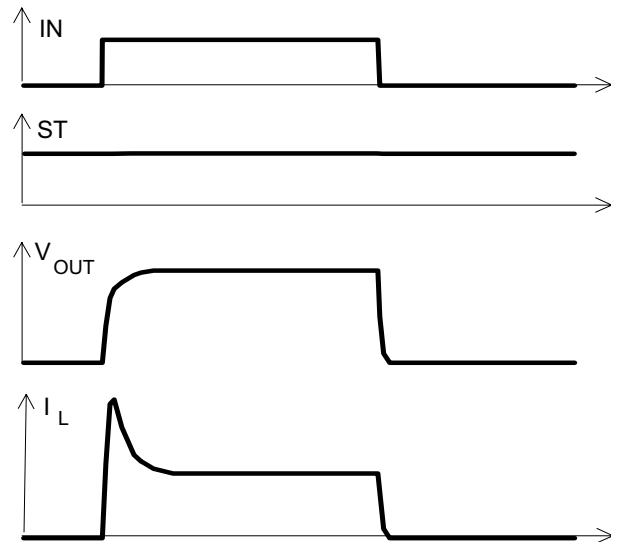


Figure 2a: Switching a resistive load, turn-on/off time and slew rate definition

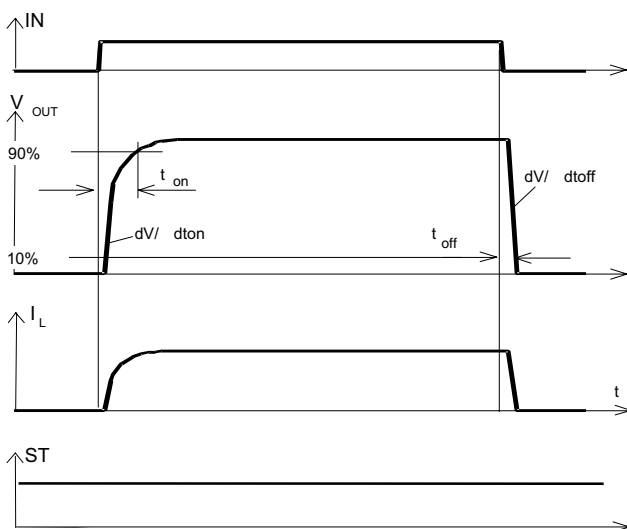


Figure 2c: Switching an inductive load

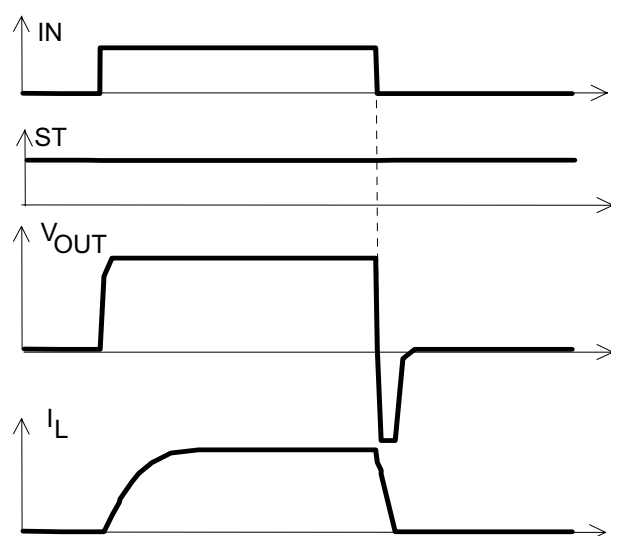
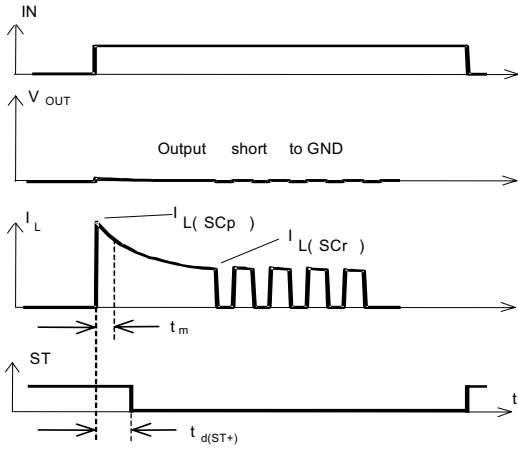


Figure 3a: Turn on into short circuit, shut down by overtemperature, restart by cooling



Heating up of the chip may require several milliseconds, depending on external conditions.

Figure 4: Overtemperature: Reset if $T_j < T_{jt}$

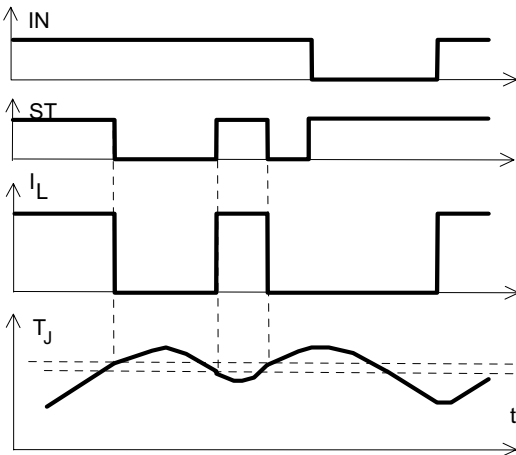


Figure 3b: Short circuit in on-state shut down by overtemperature, restart by cooling

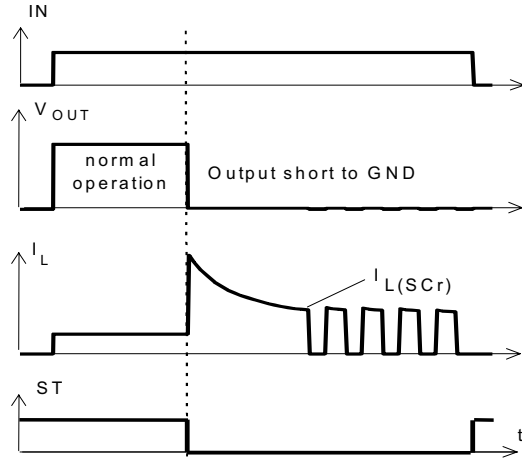


Figure 5: Undervoltage restart of charge pump

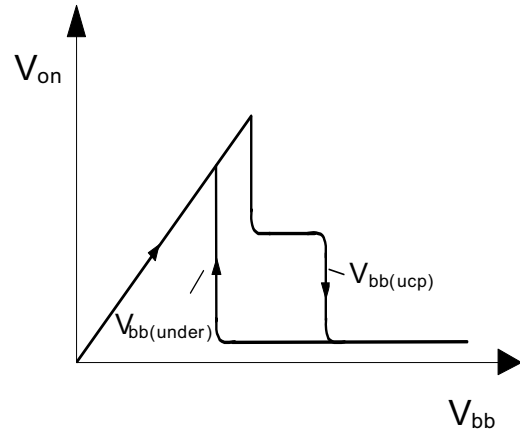
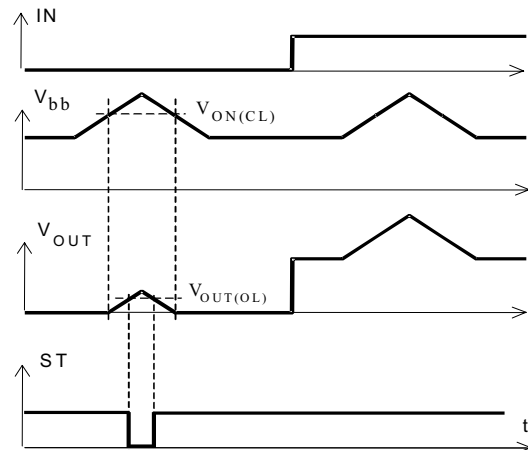


Figure 7: Overvoltage



Package Outlines

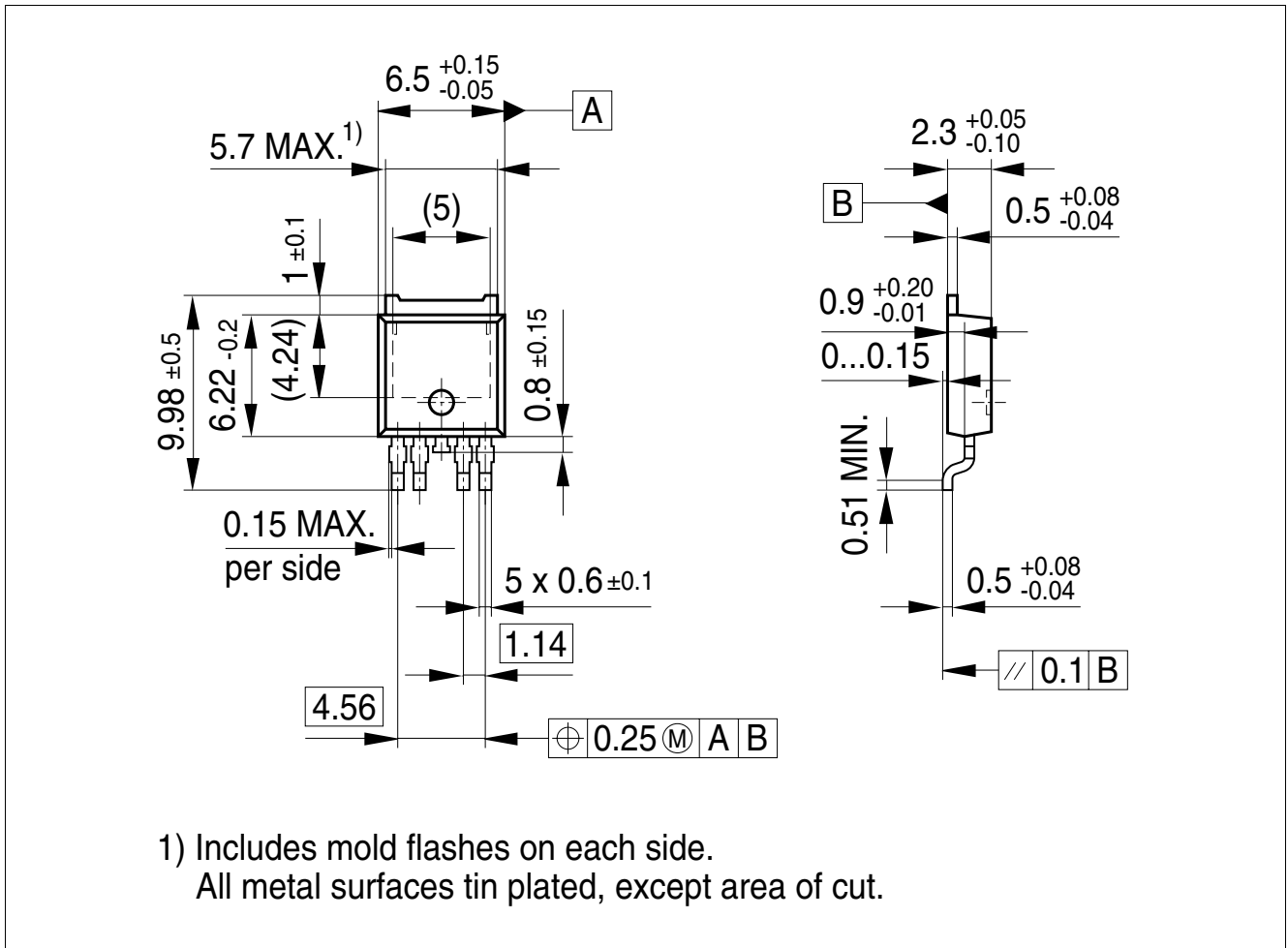


Figure 1 PG-TO252-5-11 (Plastic Dual Small Outline Package) (RoHS-compliant)

Green Product

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e. Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order.

Revision History

Version	Date	Changes
V1.0	2004-01-27	initial version
V1.1	2007-01-15	AEC icon added RoHS icon added Green product (RoHS-compliant) added to the feature list Package information updated to green Green explanation added

Edition 2007-01-15

**Published by
Infineon Technologies AG
81726 Munich, Germany**

**© Infineon Technologies AG 2007.
All Rights Reserved.**

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenhheitsgarantie"). With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.